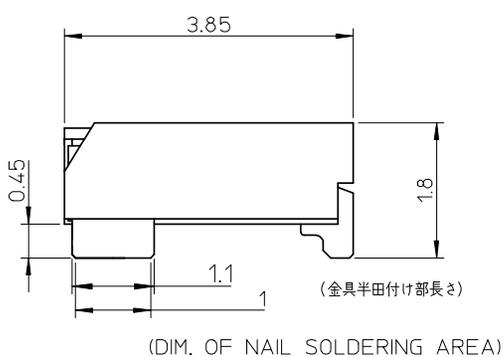
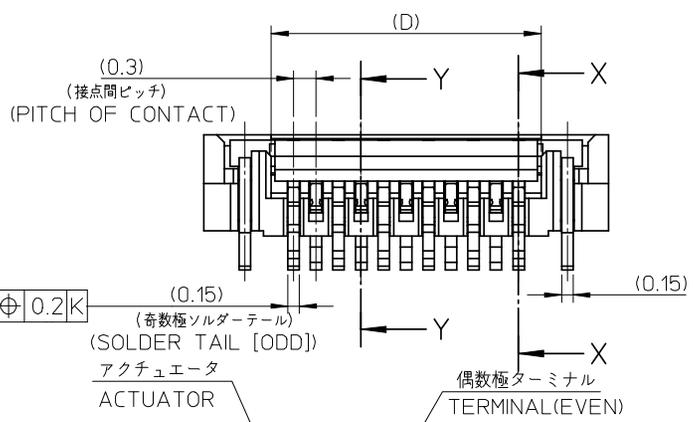
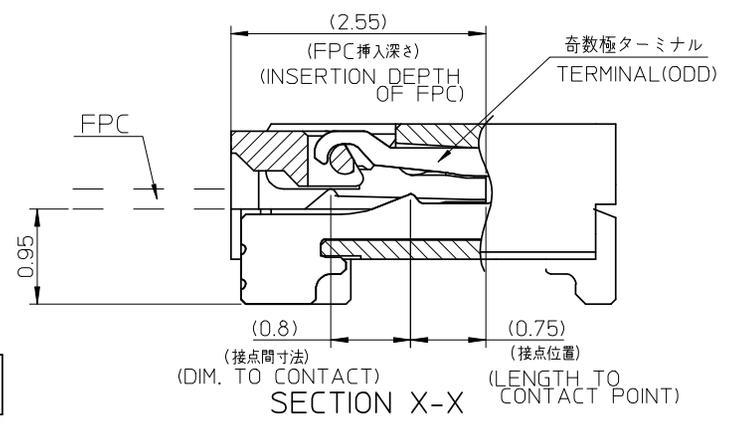
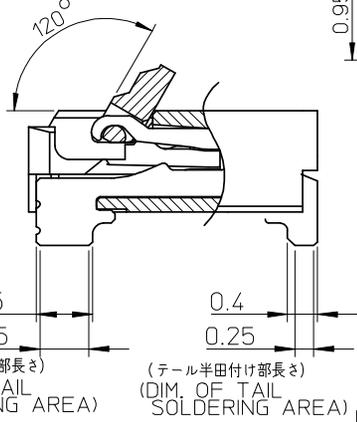
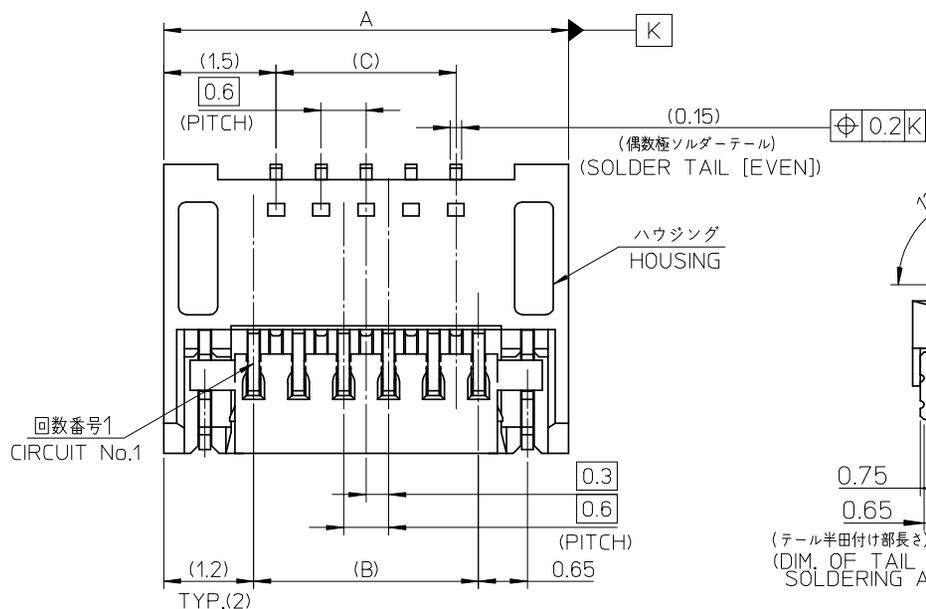
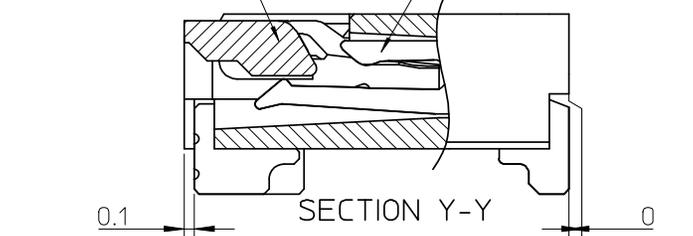


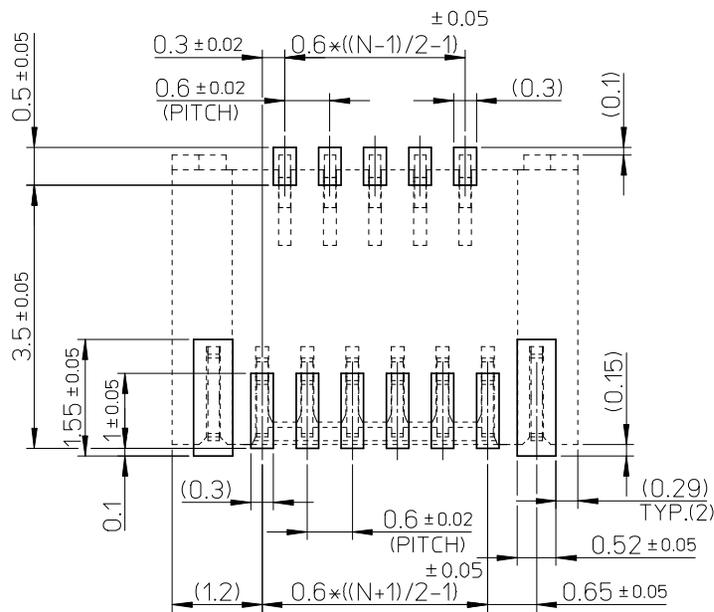
10 9 8 7 6 5 4 3 2 1



15.6	14.4	15.0	17.4	501912-5190	501912-5110	51
14.4	13.2	13.8	16.2	501912-4790	501912-4710	47
13.8	12.6	13.2	15.6	501912-4590	501912-4510	45
12.6	11.4	12.0	14.4	501912-4190	501912-4110	41
12.0	10.8	11.4	13.8	501912-3990	501912-3910	39
11.4	10.2	10.8	13.2	501912-3790	501912-3710	37
10.8	9.6	10.2	12.6	501912-3590	501912-3510	35
10.2	9.0	9.6	12.0	501912-3390	501912-3310	33
8.4	7.2	7.8	10.2	501912-2790	501912-2710	27
7.8	6.6	7.2	9.6	501912-2590	501912-2510	25
7.2	6.0	6.6	9.0	501912-2390	501912-2310	23
6.6	5.4	6.0	8.4	501912-2190	501912-2110	21
4.8	3.6	4.2	6.6	501912-1590	501912-1510	15
D	C	B	A	EMBOSSED-TAPE PKG ORDER No.	MATERIAL No.	CIRCUIT



REVISED EC NO: J2008-3324 DRWN: HTAGAMI 2008/03/25 CHKD: KAKAHASHI 2008/04/07 APPR: KAKAHASHI 2008/04/07	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
			MM ONLY	15:1	METRIC	
	10 UNDER	±0.2	DRAWN BY	DATE	TITLE	
	10 OVER 30 UNDER	±0.25	M. HAYASHI	2005/07/28	0.3 FPC CONN E/O HSG ASSY (HGT=1.8MM) GOLDPLATING	
	30 OVER	±0.3	H. HIRATA	2005/07/28		
ANGULAR ±3°		APPROVED BY	DATE	MOLEX INCORPORATED		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		M. SASAO	2005/07/28	MATERIAL NO.	DOCUMENT NO.	SHEET NO.
		SEE TABLE		SD-501912-001	1 OF 2	
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

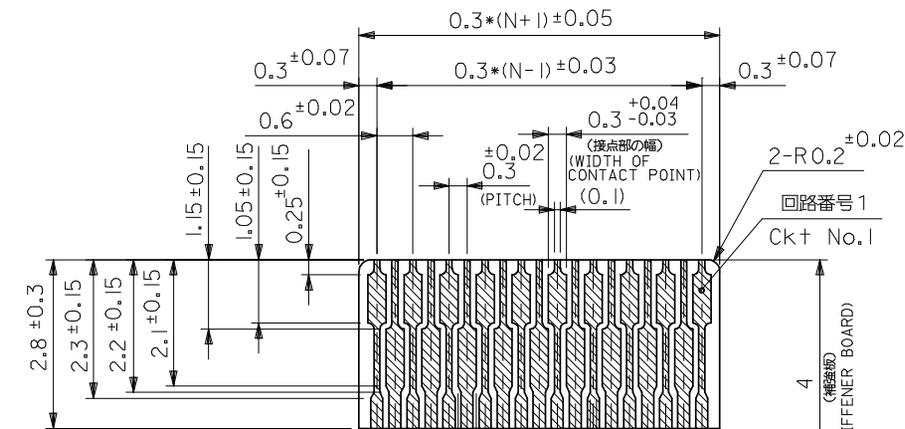


参考基板レイアウト図  
(マウント面)  
(MOUNTING SIDE)

注記 NOTES

- 使用材料 MATFRIAL  
 ハウジング : 耐熱性樹脂 ガラス充填 UL94V-0  
 HOUSING : HEAT RESISTANCE POLYMER (GLASS FILLED) UL94V-0  
 アクチュエータ : 耐熱性樹脂 ガラス充填 UL94V-0  
 ACTUATOR : HEAT RESISTANCE POLYMER (GLASS FILLED) UL94V-0  
 ターミナル : 銅合金 (t=0.15), ニッケル下地金メッキ  
 TERMINAL : COPPER ALLOY, GOLD OVER NICKEL PLATING.  
 金具 : 銅合金 (t=0.15), ニッケル下地スズメッキ  
 FITTING NAIL : COPPER ALLOY, TIN OVER NICKEL PLATING.  
 ハウジングに黒点がある場合が有りますが、問題はありません。

- ソルダーテール半田付け面、及び金具半田付け面の平坦度 : 0.1mm MAXIMUM.  
 COPLANARITY OF SOLDER TAILS AND FITTING NAILS  
 TO BE 0.1mm MAXIMUM.
- ELV AND RoHS COMPLIANT.



適合FPC推奨寸法  
APPLICABLE FPC  
RECOMMENDED DIMENSION  
(仕上がり厚さ : 0.2 ± 0.03)  
(THICKNESS : 0.2 ± 0.03)

FPCについて :

打抜き方向は導体側から補強板側を推奨いたします。  
 導体部については軟銅箔35マイクロメートルまたは50マイクロメートルを  
 推奨致します。  
 補強フィルム材質はポリイミドを推奨します。  
 接着剤は熱硬化接着剤を推奨します。

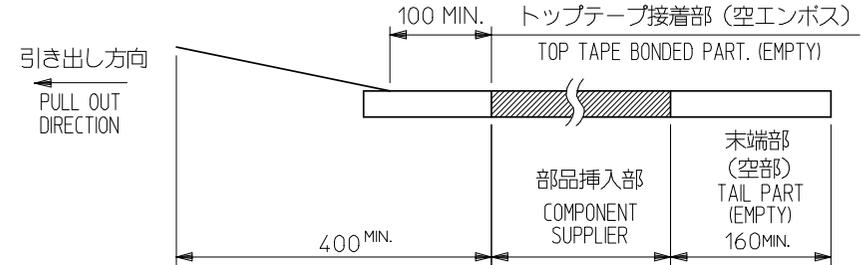
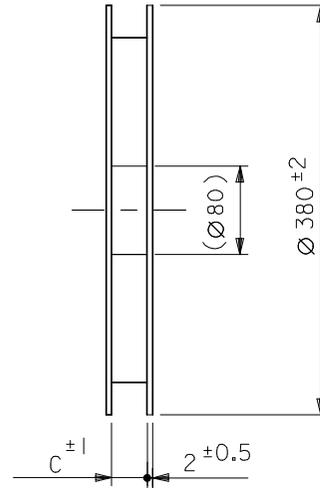
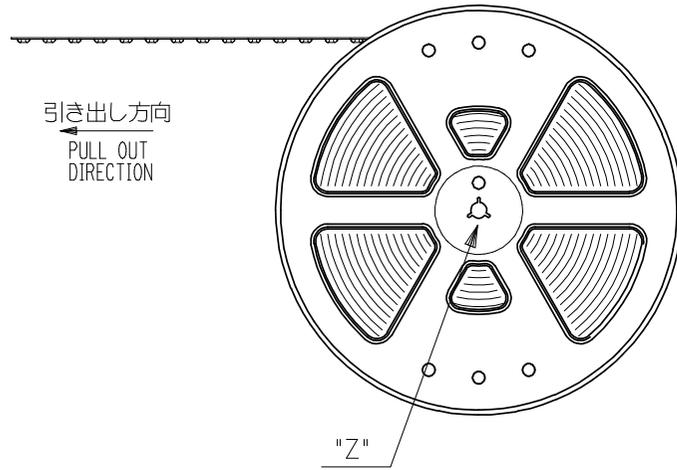
ABOUT FPC

RECOMMENDED PUNCHER DIRECTION : FROM CONDUCTOR SIDE TO STIFFENER FILM SIDE.  
 RECOMMENDED CONDUCTOR SPEC :  
 THICKNESS OF SOFT COPPER FOIL : 35 MICROMETER OR 50 MICROMETER  
 RECOMMENDED MATERIAL :  
 STIFFENER FILM : POLYIMIDE  
 BONDING AGENT : THERMOSETTING BONDING AGENT

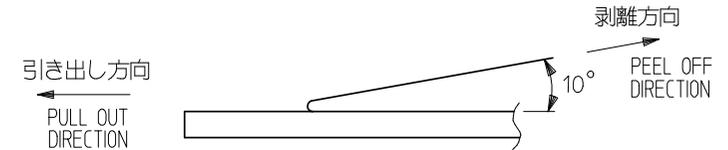
REVISED EC NO: J2008-3324 DRAWN: H. TAGAMI 2008/03/25 CHKD: K. TAKAHASHI 2008/04/07 APPR: K. TAKAHASHI 2008/04/07	DESCRIPTION 10 UNDER 10 OVER 30 UNDER 30 OVER	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ----	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		±0.2	±0.25	±0.3	DRAWN BY M. HAYASHI	DATE 2005/07/28	TITLE 0.3 FPC CONN E/O HSG ASSY (HGT=1.8MM) GOLDPLATING			
		±3°	±0.25	±0.3	CHECKED BY H. HIRATA	DATE 2005/07/28	MOLEX INCORPORATED			
		±0.25	±0.3	±0.3	APPROVED BY M. SASAO	DATE 2005/07/28	MATERIAL NO. SEE SHEET 1 DOCUMENT NO. SD-501912-001 SHEET NO. 2 OF 2			
ANGULAR ±3° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

NOTES

- 製品詳細寸法は製品単体図面を参照して下さい。  
FOR DETAIL OF CONNECTOR DIMENSIONS, PLEASE SEE THE DRAWING OF CONNECTOR ITSELF (NOT PACKAGED).
- 梱包数量：3000個/リール  
NUMBER OF CONNECTORS : 3000PCS/REEL
- リードテープ長さ LEAD TAPE LENGTH



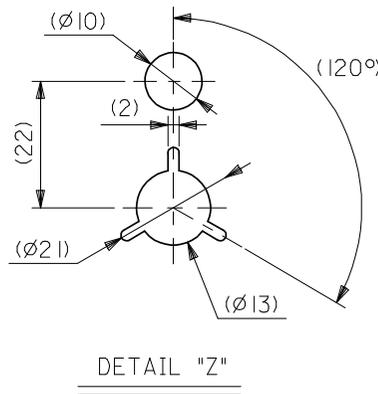
- トップテープの剥離強度：60±35gf (0.25N～0.93N) (剥離方向は下図参照) 尚、本規格値は出荷時に適用。(但し、輸送時に剥離が発生しないこと。)  
PEELING OFF FORCE OF TOP TAPE : 65gf±30gf (0.25N～0.93N) (PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.) THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT. PEEL OFF SHOULD NOT BE ALLOWED, DURING TRANSPORTATION.



5. 材料(MATERIAL)

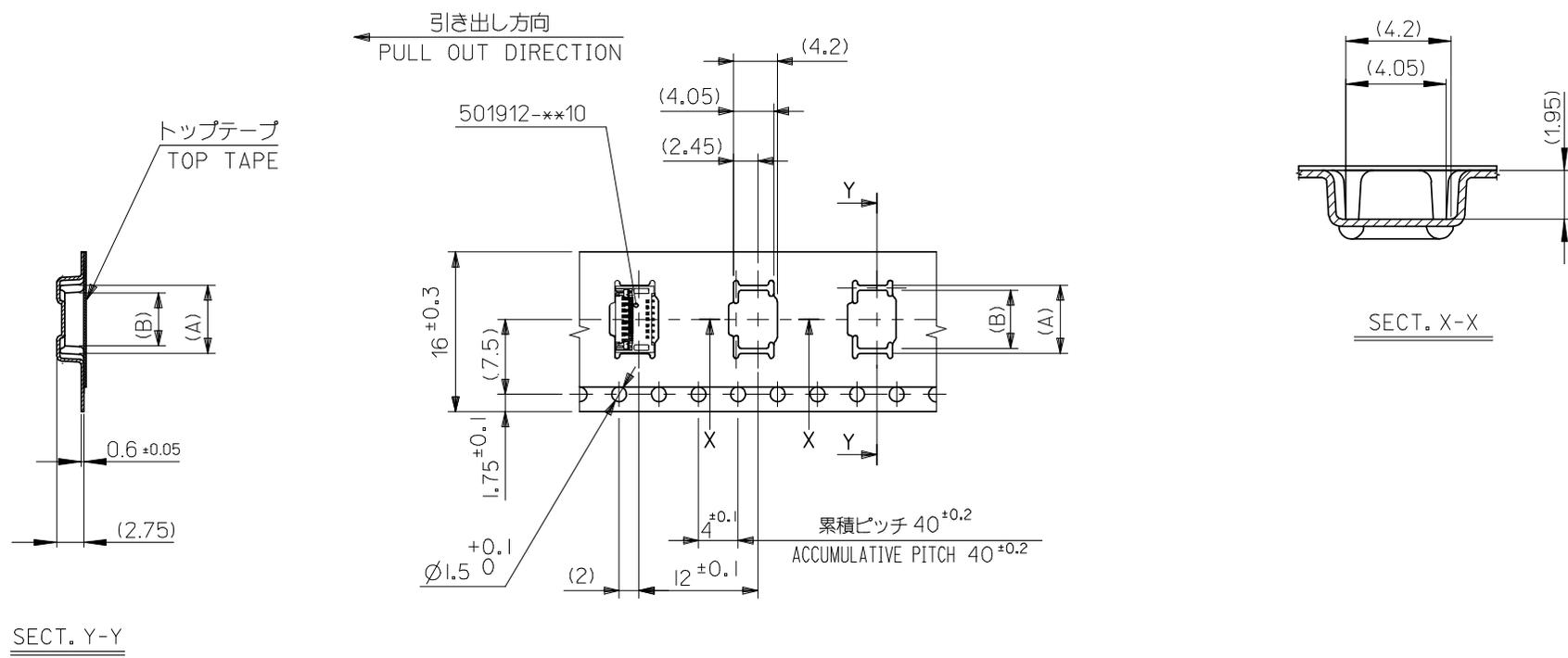
キャリアテープ (CARRIER TAPE) : ポリスチレン (POLYSTYREN)  
 トップテープ (TOP TAPE) : PET, PE, PEF  
 リール(REEL) : ポリスチレン(PS) <リサイクル材を含む>  
 POLYSTYREN(PS) <RECYCLE MATERIAL CONTAINED>

- C寸法は SHEET 2-4を参照下さい。  
SEE SHEET 2-4(DIMENSION C).
- ELV AND RoHS COMPLIANT.



DETAIL "Z"

REVISED EC NO: J2008-3324 DRAWN: TAGAMI 2008/03/25 CHKD: TAKAHASHI 2008/04/07 APPR: KITAKAHASHI 2008/04/07	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	MODEL NO. 501912-**-90	THIRD ANGLE PROJECTION
	10 UNDER	±0.2	DRAWN BY M. HAYASHI	DATE 2005/10/11	TITLE EMBSTP PKG FOR 0.3 FPC CONN (HGT=1.8MM) GOLD PLATING			
	10 OVER 30 UNDER	±0.25	CHECKED BY H. HIRATA	DATE 2005/10/11	MOLEX INCORPORATED			
	30 OVER	±0.3	APPROVED BY M. SASAO	DATE 2005/10/11	DOCUMENT NO. SD-501912-002			
	ANGULAR ±3 °		MATERIAL NO. SEE TABLE		SHEET NO. 1 OF 4			
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					



16 mm幅キャリアテープ  
16mm WIDTH CARRIER TAPE

16	17.5	4.6	6.8	501912-1590	15
キャリアテープ幅 CARRIER TAPE WIDTH	C	(B)	(A)	製品番号 MATERIAL No.	極数 CK+
				501912-**90	MODEL No.

REVISED EC NO: J2008-3324 DRWN:HTAGAMI 2008/03/25 CHKD:KTAKAHASHI 2008/04/07 APPR:KTAKAHASHI 2008/04/07 T REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	± 0.2	DRAWN BY M. HAYASHI	DATE 2005/10/11	TITLE EMBSTP PKG FOR 0.3 FPC CONN (HGT=1.8MM) GOLD PLATING		
	10 OVER 30 UNDER	± 0.25	CHECKED BY H. HIRATA	DATE 2005/10/11			
	30 OVER	± 0.3	APPROVED BY M. SASAO	DATE 2005/10/11	MOLEX INCORPORATED		
	ANGULAR	± 3 °	MATERIAL NO.	DOCUMENT NO.			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-501912-002		2 OF 4	
SIZE A3 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

F

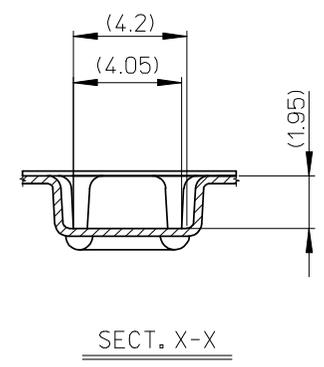
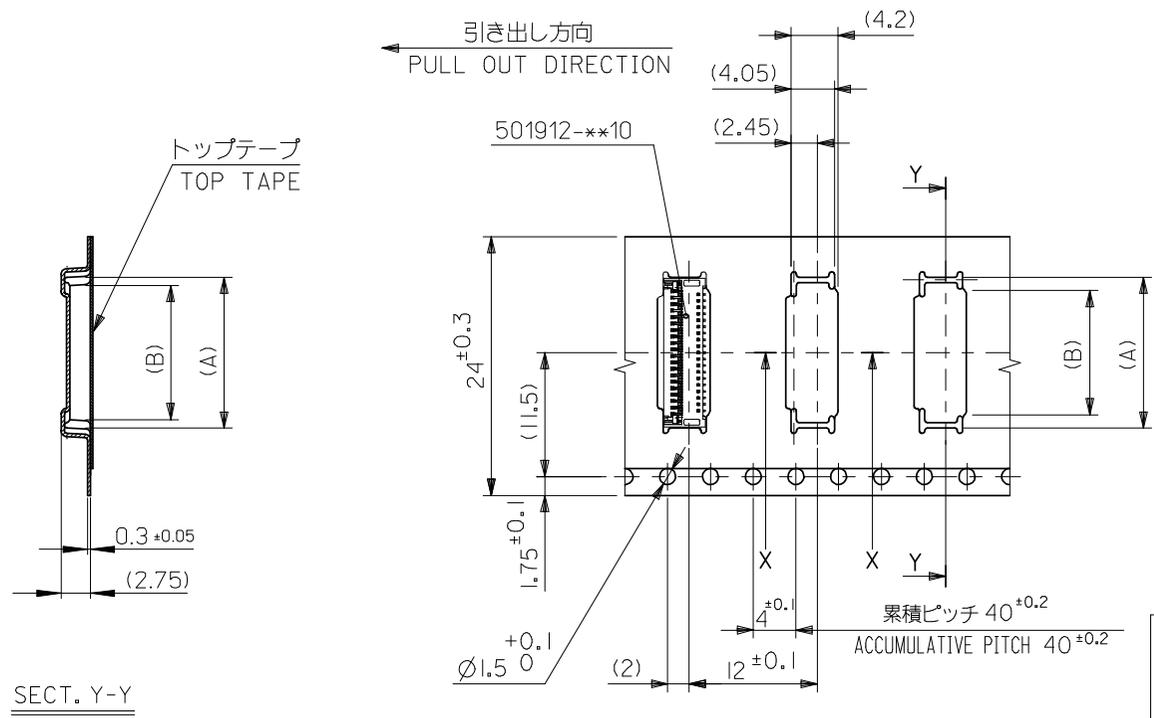
E

D

C

B

A



SECT. Y-Y

SECT. X-X

24mm幅キャリアテープ  
24mm WIDTH CARRIER TAPE

24	25.5	12.4	14.6	501912-4190	41	
		11.8	14.0	501912-3990	39	
		11.2	13.4	501912-3790	37	
		10.6	12.8	501912-3590	35	
		10.0	12.2	501912-3390	33	
		8.2	10.4	501912-2790	27	
		7.6	9.8	501912-2590	25	
		7.0	9.2	501912-2390	23	
		6.4	8.6	501912-2190	21	
キャリアテープ幅 CARRIER TAPE WIDTH		C	(B)	(A)	製品番号 MATERIAL No.	極数 CK+
				501912-**90	MODEL No.	

REVISED EC NO: J2008-3324 DRWN:HTAGAMI 2008/03/25 CHKD:KTAKAHASHI 2008/04/07 APPR:KTAKAHASHI 2008/04/07	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER	±0.2	DRAWN BY M. HAYASHI	DATE 2005/10/11	TITLE EMBSTP PKG FOR 0.3 FPC CONN (HGT=1.8MM) GOLD PLATING			
	10 OVER 30 UNDER	±0.25	CHECKED BY H. HIRATA	DATE 2005/10/11				
	30 OVER	±0.3	APPROVED BY M. SASAO	DATE 2005/10/11	MOLEX INCORPORATED			
	ANGULAR	±3 °	MATERIAL NO.	DOCUMENT NO.				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-501912-002		3 OF 4		
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



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Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

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